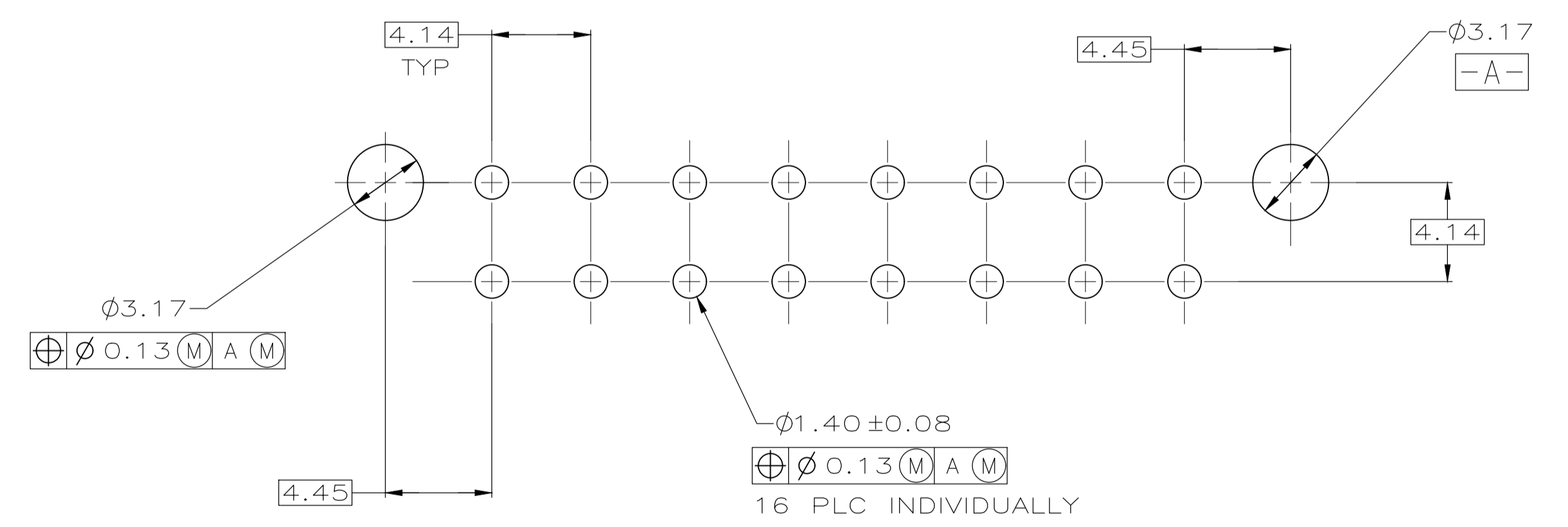
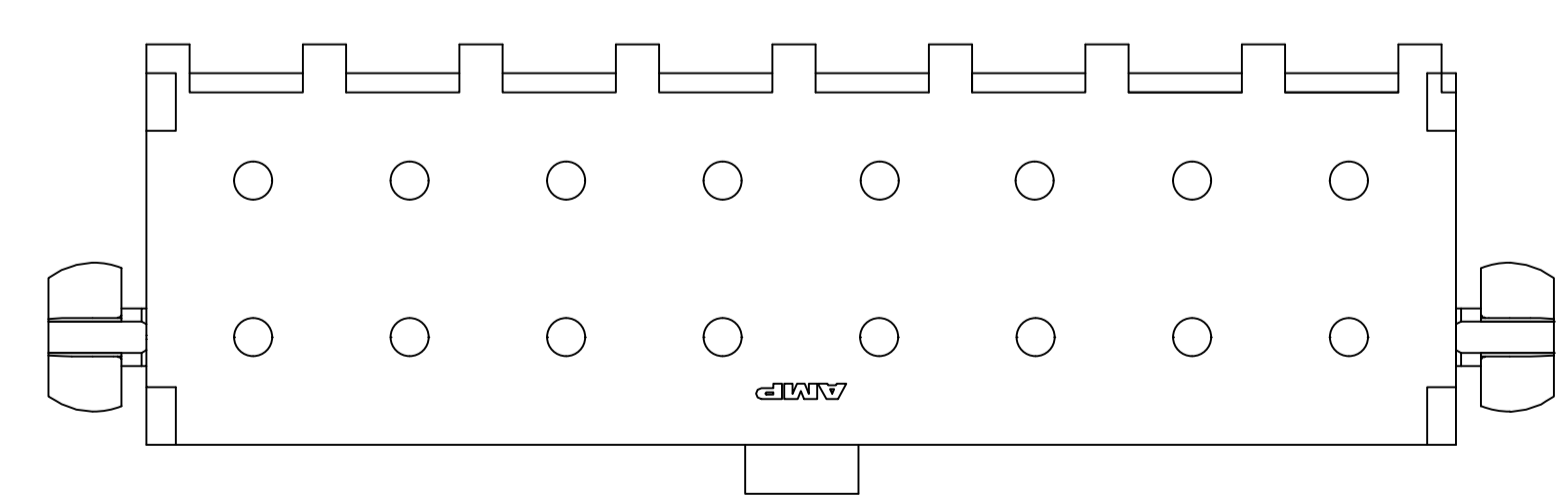
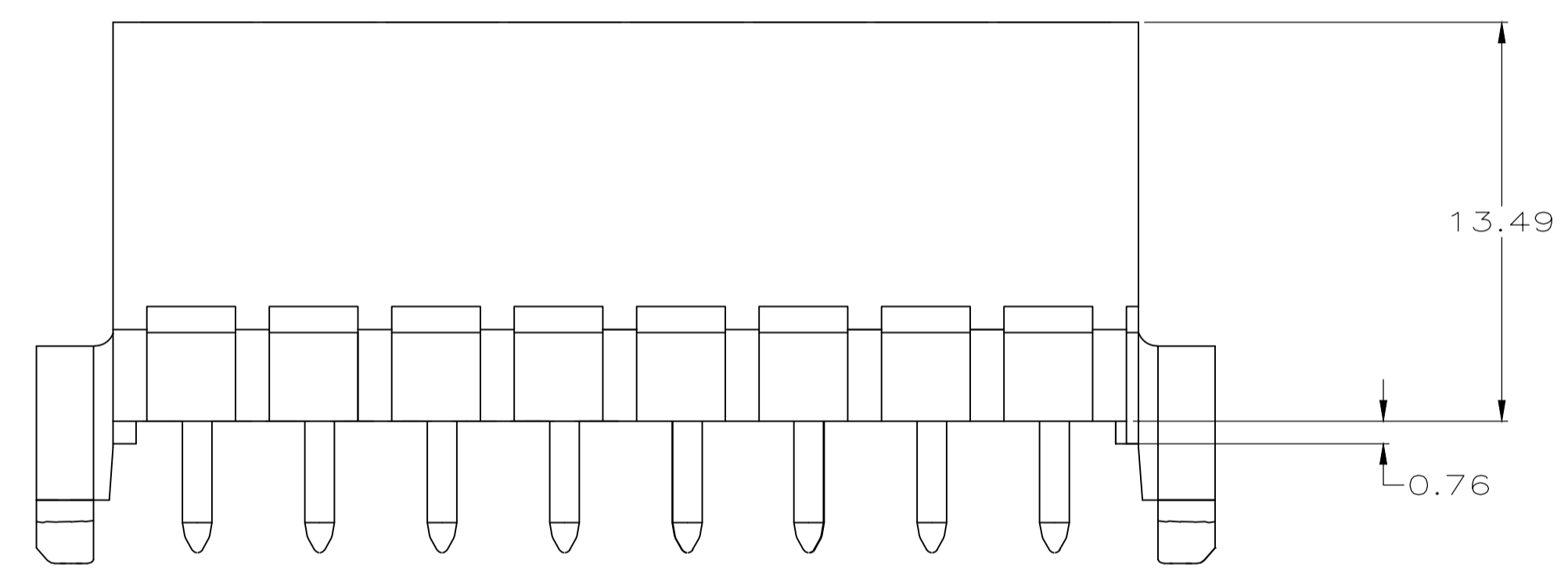


- PINS TO COMPLY WITH AMP SOLDERABILITY SPEC. 108-11-3.
- 0.00381 MIN MATTE TIN LEAD OVER 0.00127 MIN NICKEL.
- 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN LEAD IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.
- 0.00381 MIN MATTE TIN OVER 0.00127 MIN NICKEL.
- 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.



RECOMMENDED MOUNTING HOLE PATTERN FOR 1.57 THICK P.C. BOARD

	BRASS, GOLD		NYLON, UL94V-0	WHITE	1-794075-1
	BRASS, TIN		NYLON, UL94V-0	WHITE	1-794075-0
OBSOLETE	BRASS, GOLD		NYLON, UL94V-0	WHITE	794075-2
	BRASS, TIN-LEAD		NYLON, UL94V-0	WHITE	794075-1
	MATERIAL	FINISH	MATERIAL	COLOR	PART NO.
	PIN		HOUSING		

THIS DRAWING IS A CONTROLLED DOCUMENT.

DESIGNED BY: S. CARPENTER	DATE: 09JUN05
CHECKED BY: R. JONES	DATE: 29JUL2003
APPROVED BY: R. JONES	DATE: 29JUL2003
NAME: R. JONES	NAME: R. JONES
PRODUCT SPEC: PRODUCT SPEC	APPLICATION SPEC: APPLICATION SPEC
SIZE: A1	SCALE: 5:1
WEIGHT: --	SHEET: 1 OF 1
CUSTOMER DRAWING	REV: F1

STE TE Connectivity

NAME: HEADER ASSEMBLY, CLOSED BOTTOM, 16 CKT, DOUBLE ROW VERTICAL, MINI UNIVERSAL MATE-N-LOK

SIZE: A1 00779 C=794075

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)